

Diode、インバータ / Diode, Inverter 最大定格 / Maximum Rated Values

ピーク繰返し逆電圧 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	650	V
連続DC電流 Continuous DC forward current		I_F	50	A
ピーク繰返し順電流 Repetitive peak forward current	$t_p = 1 \text{ ms}$	I_{FRM}	100	A
電流二乗時間積 I^2t - value	$V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$ $V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I^2t	330 300	A^2s A^2s

電気的特性 / Characteristic Values

		min. typ. max.					
順電圧 Forward voltage	$I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}$ $I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}$ $I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	V_F		1,55 1,50 1,45	1,95	V V V
ピーク逆回復電流 Peak reverse recovery current	$I_F = 50 \text{ A}, -di_F/dt = 2800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	I_{RM}		69,0 76,0 80,0		A A A
逆回復電荷量 Recovered charge	$I_F = 50 \text{ A}, -di_F/dt = 2800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	Q_r		1,90 3,40 3,95		μC μC μC
逆回復損失 Reverse recovery energy	$I_F = 50 \text{ A}, -di_F/dt = 2800 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 300 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{rec}		0,60 0,95 1,10		mJ mJ mJ
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	/Diode (1 素子当り) / per diode		R_{thJC}			1,20	K/W
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	/Diode (1 素子当り) / per diode $\lambda_{Paste} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}		0,562		K/W
動作温度 Temperature under switching conditions			$T_{vj op}$	-40		150	$^{\circ}\text{C}$

Diode、整流器 / Diode, Rectifier 最大定格 / Maximum Rated Values

ピーク繰返し逆電圧 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1600	V
最大実効順電流/chip Maximum RMS forward current per chip	$T_c = 80^{\circ}\text{C}$	I_{FRMSM}	80	A
整流出力の最大実効電流 Maximum RMS current at rectifier output	$T_c = 80^{\circ}\text{C}$	I_{RMSM}	100	A
サージ順電流 Surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I_{FSM}	600 470	A A
電流二乗時間積 I^2t - value	$t_p = 10 \text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I^2t	1800 1100	A^2s A^2s

電気的特性 / Characteristic Values

		min. typ. max.				
順電圧 Forward voltage	$T_{vj} = 150^{\circ}\text{C}, I_F = 50 \text{ A}$	V_F		1,00	V	
逆電流 Reverse current	$T_{vj} = 150^{\circ}\text{C}, V_R = 1600 \text{ V}$	I_R		1,00	mA	
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	/Diode (1 素子当り) / per diode		R_{thJC}		0,650	K/W
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	/Diode (1 素子当り) / per diode $\lambda_{Paste} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}		0,304	K/W
動作温度 Temperature under switching conditions			$T_{vj op}$	-40		150 $^{\circ}\text{C}$

IGBT-ブレーキチョッパー / IGBT, Brake-Chopper

最大定格 / Maximum Rated Values

コレクタ・エミッタ間電圧 Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	650	V
連続DCコレクタ電流 Continuous DC collector current	$T_C = 80^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$	$I_{C\text{nom}}$ I_C	50 70	A A
繰り返しピークコレクタ電流 Repetitive peak collector current	$t_P = 1\text{ms}$	I_{CRM}	100	A
ゲート・エミッタ間ピーク電圧 Gate-emitter peak voltage		V_{GES}	+/-20	V

電気的特性 / Characteristic Values

		min.	typ.	max.	
コレクタ・エミッタ間飽和電圧 Collector-emitter saturation voltage	$I_C = 50\text{A}, V_{GE} = 15\text{V}$ $I_C = 50\text{A}, V_{GE} = 15\text{V}$ $I_C = 50\text{A}, V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_{CE\text{sat}}$	1,55 1,70 1,75	1,95 V V V
ゲート・エミッタ間しきい値電圧 Gate threshold voltage	$I_C = 0,80\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		V_{GEth}	5,05 5,80 6,45	V
ゲート電荷量 Gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$		Q_G	0,50	μC
内蔵ゲート抵抗 Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		R_{Gint}	0,0	Ω
入力容量 Input capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		C_{ies}	3,10	nF
帰還容量 Reverse transfer capacitance	$f = 1\text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		C_{res}	0,095	nF
コレクタ・エミッタ間遮断電流 Collector-emitter cut-off current	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{CES}		1,0 mA
ゲート・エミッタ間漏れ電流 Gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}		100 nA
ターンオン遅れ時間 (誘導負荷) Turn-on delay time, inductive load	$I_C = 50\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{don}	0,023 0,023 0,023	μs μs μs
ターンオン上昇時間 (誘導負荷) Rise time, inductive load	$I_C = 50\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Gon} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_r	0,015 0,018 0,02	μs μs μs
ターンオフ遅れ時間 (誘導負荷) Turn-off delay time, inductive load	$I_C = 50\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{doff}	0,18 0,20 0,205	μs μs μs
ターンオフ下降時間 (誘導負荷) Fall time, inductive load	$I_C = 50\text{A}, V_{CE} = 300\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_f	0,055 0,06 0,06	μs μs μs
ターンオンスイッチング損失 Turn-on energy loss per pulse	$I_C = 50\text{A}, V_{CE} = 300\text{V}, L_S = 30\text{nH}$ $V_{GE} = \pm 15\text{V}, di/dt = 2800\text{A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Gon} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{on}	0,33 0,375 0,475	mJ mJ mJ
ターンオフスイッチング損失 Turn-off energy loss per pulse	$I_C = 50\text{A}, V_{CE} = 300\text{V}, L_S = 30\text{nH}$ $V_{GE} = \pm 15\text{V}, du/dt = 4200\text{V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Goff} = 8,2\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{off}	1,80 2,25 2,40	mJ mJ mJ
短絡電流 SC data	$V_{GE} \leq 15\text{V}, V_{CC} = 360\text{V}$ $V_{CE\text{max}} = V_{CES} - L_{SCE} \cdot di/dt$	$t_P \leq 10\mu\text{s}, T_{vj} = 25^{\circ}\text{C}$ $t_P \leq 10\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$	I_{SC}	240 190	A A
ジャンクション・ケース間熱抵抗 Thermal resistance, junction to case	IGBT部 (1素子当り) / per IGBT		R_{thJC}		0,800 K/W
ケース・ヒートシンク間熱抵抗 Thermal resistance, case to heatsink	IGBT部 (1素子当り) / per IGBT $\lambda_{\text{Paste}} = 1\text{W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1\text{W}/(\text{m}\cdot\text{K})$		R_{thCH}	0,375	K/W
動作温度 Temperature under switching conditions			$T_{vj\text{op}}$	-40	150 $^{\circ}\text{C}$